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- Tentative Specification
- □ Preliminary Specification
- □ Approval Specification

# MODEL NO.: G057VCE SUFFIX: TH1

Customer:	
APPROVED BY	SIGNATURE
<b>Name / Title</b> Note	
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Approved By	Checked By	Prepared By



# PRODUCT SPECIFICATION

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### **REVISION HISTORY**

Version	Date	Page	Description
Ver 0.0	12 Oct 2021	All	Tentative Specification was first issued.



#### **1. GENERAL DESCRIPTION**

#### **1.1 OVERVIEW**

G057VCE-TH1is a 5.7" TFT Liquid Crystal Display IAV module with LED Backlight units and 40 pins 1ch-TTL interface. This module supports 640 x 480 VGA mode and can display 262k colors.

The PSWG is to establish a set of displays with standard mechanical dimensions and select electrical interface requirements for an industry standard 5.7" VGA LCD panel and the LED driving device for Backlight is built in PCBA.

#### **1.2 FEATURE**

- VGA (640 x 480 pixels) resolution
- DE (Data Enable) mode and DE+SYNC mode selection
- TTL Interface
- PSWG (Panel Standardization Working Group)
- Wide operating temperature.
- Reversible scan direction
- RoHS compliance

#### 1.3 APPLICATION

- -TFT LCD Monitor
- Factory Application
- Amusement

#### **1.4 GENERAL SPECIFICATIONS**

Item	Specification	Unit	Note
Active Area	115.2 (H) x 86.4 (V) (5.7" diagonal)	mm	(1)
Driver Element	a-Si TFT active matrix	-	-
Pixel Number	640 x R.G.B x 480	pixel	-
Pixel Pitch	0.18(H) x 0.18(W)	mm	-
Pixel Arrangement	RGB vertical Stripe	-	-
Display Colors	262K	color	-
Display Mode	Normally Black	-	-
Surface Treatment	Hard Coating (3H), Anti-Glare	-	-
Module Power Consumption	TBD( PanelTBD+BL 2.3W)	W	Тур.





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## **PRODUCT SPECIFICATION**

### **1.5 MECHANICAL SPECIFICATIONS**

lte	em	Min.	Тур.	Max.	Unit	Note	
	Horizontal(H)	143.5	144	144.5	mm		
Module Size	Vertical(V)	104.1	104.6	105.1	mm	(1)	
Depth	Depth(D)	11.8	12.3	12.8	mm		
Rozal Araa	Horizontal	117.6	118.2	118.4	mm	-	
Bezel Alea	Vertical	88.8	89.4	89.6	mm		
Active Area	Horizontal	-	115.2	-	mm		
Active Area	Vertical	-	86.4	-	mm		
We	eight	-	(TBD)		g		

Note (1)Please refer to the attached drawings for more information of front and back outline dimensions.





### 2. ABSOLUTE MAXIMUM RATINGS

#### 2.1 ABSOLUTE RATINGS OF ENVIRONMENT

ltom	Symbol	Va	lue	Linit	Noto
item	Symbol	Min.	Max.		NOLE
Operating Ambient Temperature	T <sub>OP</sub>	-30	+85	°C	(1)(2)
Storage Temperature	T <sub>ST</sub>	-40	+85	°C	(1)(2)

Note (1)

(a) 90 %RH Max.

(b) Wet-bulb temperature should be 39 °C Max.

(c) No condensation.

Note (2) Panel surface temperature should be 0°C min. and 65°C max under Vcc=5.0V, fr =60Hz, typical LED string current, 25°C ambient temperature, and no humidity control. Any condition of ambient operating temperature ,the surface of active area should be keeping not higher than 85°C.





### 2.2 ELECTRICAL ABSOLUTE RATINGS

### 2.2.1 TFT LCD MODULE

Itom	Symbol			Linit	Noto	
Item	Symbol	Min.	Max.	Unit	NOLE	
Power Supply Voltage	VCC	-0.3	4	V	(1)	
Logic Input Voltage	Vin	-0.3	4	V	(1)	

### 2.2.2 BACKLIGHT UNIT

Item	Symbol	Va	lue	Linit	Nete	
	Symbol	Min.	Max.	Onic	Note	
Converter Voltage	Vi	-0.3	18	V	(1) , (2)	
Enable Voltage	EN		5.5	V		
Backlight Adjust	Dimming		5.5	V		

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation

should be restricted to the conditions described under Normal Operating Conditions.

Note (2) Specified values are for LED (Refer to 3.2 for further information).





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### **3. ELECTRICAL CHARACTERISTICS**

### 3.1 TFT LCD MODULE

Parameter		Symphol	Value			Linit	Noto
		Symbol	Min.	Тур.	Max.		Note
Power Supply Vo	oltage	V <sub>CC</sub>	3.0	3.3	3.6	V	-
Ripple Voltage		V <sub>RP</sub>	-	-	100	mVp-p	
Inrush Current		I <sub>INRUSH</sub>	-	-	2.0	A	(2)
Dowor Supply Current	White	lcc	-	TBD	TBD	mA	(3)a
Power Supply Current	Black		-	TBD	TBD	mA	(3)b
Power Consumption		PL	-	TBD	-	W	
Logic High Input Voltage		VIH	0.7V <sub>CC</sub>		V <sub>CC</sub>	V	
Logic Low Input V	oltage	VIL	GND		0.3V <sub>CC</sub>	V	

Note (1)The module should be always operated within above ranges.

Note (2)Measurement Conditions:





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Note (3) The specified power supply current is under the conditions at V<sub>DD</sub> =3.3V, Ta = 25 ± 2 °C, DC Current

and  $f_v = 60$  Hz, whereas a power dissipation check pattern below is displayed.

a. White Pattern



Active Area

#### b. Black Pattern



Active Area

#### 3.2 BACKLIGHT UNIT

Paramo	eter	Symbol	Min.	Тур.	Max.	Unit	Note	
Converter Inp	ut Voltage	Vi	10.8	12.0	13.2	V <sub>DC</sub>	(Duty 100%)	
Converter Input F	Ripple Voltage	V <sub>iRP</sub>	-	-	500	mV		
Converter Inp	ut Current	li	0.16	0.19	0.22	A <sub>DC</sub>	@ Vi = 12V (Duty 100%)	
Converter Inrush Current		I <sub>lrush</sub>	-	-	3.0	А	@ Vi rising time=10ms (Vi=12V)	
Input Power Consumption		Pi	-	2.3		W	(1)	
	Backlight on	ENLED	2.0	3.3	5.0	V		
EN Control Level	Backlight off	(BLON)	0	-	0.3	V		
DW/M Control Loval	PWM High Level	Dimming	2.0	-	5.0	V		
P VVIVI CONITOI Level	PWM Low Level	(E_PWM)	0	-	0.15	V		
PWN Noise	Range	VNoise	-	-	0.1	V		
PWM Control	Frequency	f <sub>PWM</sub>	190	200	20k	Hz	(2)	
	atral Duty Datia		5	-	100	%	(2), @ 190Hz <f<sub>PWM&lt;1kHz</f<sub>	
PWM Dimming Control Duty Ratio		-	20	-	100	%	(2), @ 1kHz≤f <sub>PWM</sub> <20kHz	
LED Life	Time	L <sub>LED</sub>	50,000		-	Hrs	(3)	



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Note (1)LED current is measured by utilizing a high frequency current meter as shown below:



- Note (2) The lifetime of LED is estimated data and defined as the time when it continues to operate under the conditions at Ta =  $25 \pm 2$  °C and Duty 100% until the brightness becomes  $\leq 50\%$  of its original value. Operating LED at high temperature condition will reduce life time and lead to color shift.
- Note (3) At 190 ~1kHz PWM control frequency, duty ratio range is restricted from 5% to 100%.

1K ~20kHz PWM control frequency, duty ratio range is restricted from 20% to 100%.

If PWM control frequency is applied in the range from 1KHz to 20KHZ, The"non-linear"phenomenon on the Backlight Unit may be found. So **F** a **suggestion** that PWM control frequency should be **less than 1KHz**.





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### 4. BLOCK DIAGRAM

4.1 TFT LCD MODULE



### 群創光電 5. INPUT TERMINAL PIN ASSIGNMENT

#### 5.1 TFT LCD MODULE

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Pin No.	Symbol	Function	Note
1	GND	Ground	
2	CLK	Dot Clock. Latch data at the rising edge.	
3	IHS	Horizontal synchronous signal	
4	IVS	Vertical synchronous signal	
5	GND	Ground	
6	R5	Red data (MSB)	
7	R4	Red data	
8	R3	Red data	
9	R2	Red data	
10	R1	Red data	
11	R0	Red data (LSB)	
12	GND	Ground	
13	G5	Green data (MSB)	
14	G4	Green data	
15	G3	Green data	
16	G2	Green data	
17	G1	Green data	
18	G0	Green data (LSB)	
19	GND	Ground	
20	B5	Blue data (MSB)	Note (3)
21	B4	Blue data	
22	B3	Blue data	
23	B2	Blue data	
24	B1	Blue data	
25	B0	Blue data (LSB)	
26	GND	Ground	
27	DE	Data Enable Signal	
28	NC	No Connection	Note (3)
29	NC	No Connection	Note (3)
30	R/I	Horizontal Reverse Scan Control,	Note (3)
		High Horizontal Reverse Scan	
		Vertical Reverse Scan Control,	Note (3)
31	U/D	High or NC Normal Mode	
		Low Vertical Reverse Scan	
32	NC	No Connection	Note (3) Note (4)
33	NC	No Connection	Note (3) Note (4)
34	NC	No Connection	Note (3) Note (4)
		DE / HV mode select.	Note (3)
35	MODE	High HV mode.	
		Low or NC DE mode.	
36	NC	No Connection	Note (3) Note (4)
37	NC	No Connection	Note (3)
38	VCC	Power supply: +3.3V	
39	VCC	Power supply: +3.3V	
40	VCC	Power supply: +3.3V	

Note (1) Connector Part No.: 20455-040E-76(I-PEX) or equivalent.

Note (2) User's connector Part No.: 20453-040T-03(I-PEX) or equivalent.

Note (3) "Low" stands for 0V. "High" stands for 3.3V. "NC" stands for "No Connection".

Note (4) Pin32, Pin33, Pin34, Pin36 input signals should be set to no connection or ground, this module would operate normally.

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### 5.2 BACKLIGHT UNIT(Converter connector pin)

Pin	Symbol	Description	Remark		
1	NC	Not Connect			
2	Dimming	Backlight Adjust	PWM Dimming (Hi: 3.3V <sub>DC</sub> , Lo: 0V <sub>DC</sub> )		
3	EN	Enable pin	3.3V		
4	V <sub>GND</sub>	Converter ground	Ground		
5	Vi	Converter input voltage	12V		

Note (1)Connector Part No.: CI4205M2HRD-NH (Cvilux) or equivalent.

Note (2)User's connector Part No.: 9827H-04-N0HF(SWB) or equivalent.



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### **5.3 COLOR DATA INPUT ASSIGNMENT**

The brightness of each primary color (red, green and blue) is based on the 6-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

									Γ	Data	Signa	al							
	Color			R	ed					Gr	een					B	lue		
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	÷	:	÷	:	:	:	:	:	:	:	:	:	:	:	:		:
Red	Red(61)	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	1	1	1	1	1	0	0	0		0	0	0	0			0	0	0
	Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0			0	0	0
0	Green(1)	0	0	0	0	0	0	0	0		0	0	1	0				0	0
Gray	Green(2)	0	0	0	0	0	0	0	0		0	1	0	0	0	0	0	0	0
Scale		:	:	:	÷	:	:	:	:		:	:	:	:					:
Croon	Croop(61)	:	:	:	:	:	:	1	1		1		1	:					:
Green	Green(61)		0	0	0	0	0	1	1		1	1		0					0
	Green(62)		0	0	0	0	0	1	1		1	1	1	0					0
	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0		0	0		0
		0	0	0	0	0	0	0	0		0	0	0	0					1
Grav		0	0	0	0	0	0	0	0		0	0	0	0					0
Scale																			
Of	· ·	:	:	:	•	•	:	:	:	:	:	:			:	:	:		:
Blue	Blue(61)	0	0	0	0	0	0	0	0	0		0	0			1	1		· 1
	Blue(62)	ő	õ	õ	Ő	õ	Ő	õ	õ	Ő	Ő	0	0	1				1	0
	Blue(63)	Ō	Õ	Õ	Õ	õ	õ	ŏ	Õ	ŏ	Õ	Õ	Õ	1	1	1	1	1	1

Note (1)0: Low Level Voltage, 1: High Level Voltage



### 6. INTERFACE TIMING

### 6.1 INPUT SIGNAL TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
	Frequency	Fr	20.5	20.7	29.8	MHz	-
	Period	Tc	33.56	48.31	48.78	ns	
DCLK	Input cycle to cycle jitter	T <sub>rcl</sub>			200	ns	(a)
DOLK	Spread spectrum modulation range	F <sub>clkin_mod</sub>	0.98*Fc	-	1.02*F <sub>c</sub>	MHz	(b)
	Spread spectrum modulation frequency	F <sub>SSM</sub>	-	-	200	KHz	(5)
	Frame Rate	Fr		60		Hz	$Tv=T_{vd}+T_{vb}$
Vertical Display	Total	Τv	488	490	611	Th	-
Term	Active Display	T <sub>vd</sub>	480	480	480	Th	-
	Blank	T <sub>vb</sub>	8	10	131	Th	-
	Total	T <sub>h</sub>	700	704	814	Tc	$T_h = T_{hd} + T_{hb}$
Horizontal Display	Active Display	T <sub>hd</sub>	640	640	640	Tc	-
i citti	Blank	T <sub>hb</sub>	60	64	174	Tc	-

Note (1) Because this module is operated by DE only mode, Hsync and Vsync input signals should be set to

low logic level or ground. Otherwise, this module would operate abnormally.

Note (2) The Tv(Tvd+Tvb) must be integer, otherwise, the module would operate abnormally.

#### **INPUT SIGNAL TIMING DIAGRAM**



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Note (a) The input clock cycle-to-cycle jitter is defined as below figures.  $T_{rcl} = I T1 - TI$ 



Note (b) The SSCG (Spread spectrum clock generator) is defined as below figures.



### 6.2 DE +SYNC MODE INPUT SIGNAL TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
DCLK	Frequency	Тс	20.5	20.7	29.8	MHz	
	Total	Τv	488	490	611	Th	
	Display	Tvd	-	480	-	Th	
Vertical Active Display Term	Front Porch	Tvf	3	5	126	Th	
	Back Porch	Tvb	5	5	5	Th	
	VS Pluse	Тvр	1	2	4	Th	
	Total	Th	700	704	814	Тс	
	Display	Thd	-	640	-	Тс	
Horizontal Active Display Term	Front Porch	Thf	28	32	142	Тс	
	Back Porch	Thb	32	32	32	Тс	
	HS Pluse	Thp	1	2	31	Тс	

Note (1) The Tv(Tvd+Tvb+Tvf+Tvp) must be integer, otherwise, the module would operate abnormally



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#### **INPUT SIGNAL TIMING DIAGRAM**



#### **6.3 AC ELECTRICAL CHARACTERISTICS**

Parameter	Symbol				Llnit	Condition	
Falametei	Symbol	Min.	Тур.	Max.	Offic	Condition	
Data setup time	Tdsu	10	-	-	ns	Note (1)	
Data hold time	Tdhd	10	-	-	ns	Note (1)	
DE setup time	Tesu	10	-	-	ns		
HS setup time	Thst	10	-	-	ns		
HS hold time	Thhd	10	-	-	ns		
VS setup time	Tvst	10	-	-	ns		
VS hold time	Tvhd	10	-	-	ns		

Note (1) CLK latching data at the rising edge.



PRODUCT SPECIFICATION

**Clock and Data input waveform** 



#### 6.4 POWER ON/OFF SEQUENCE

To prevent a latch-up or DC operation of LCD assembly, the power on/off sequence should be as the diagram below.



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Doromotor		Linits		
Farameter	Min	Тур	Max	Units
T1	0.5	-	10	ms
T2	0	-	50	ms
Т3	0	-	50	ms
T4	500	-	-	ms
T5	450	-	-	ms
Т6	200	-	-	ms
Τ7	10	-	100	ms
Т8	10	-	-	ms
Т9	10	-	-	ms
T10	20	-	50	ms

Note(1) The supply voltage of the external system for the module input should be the same as the definition of Vcc.

Note(2) When the backlight turns on before the LCD operation of the LCD turns off, the display may momentarily become abnormal screen.

- Note(3) In case of VCC = off level, please keep the level of input signals on the low or keep a high impedance.
- Note(4) T4 should be measured after the module has been fully discharged between power off and on period.
- Note(5) Interface signal shall not be kept at high impedance when the power is on.
- Note(6) INX won't take any responsibility for the products which are damaged by the customers not following the Power Sequence.
- Note(7) There might be slight electronic noise when LCD is turned off (even backlight unit is also off). To avoid this symptom, we suggest "Vcc falling timing" to follow "T7 spec



### **6.5 SCANNING DIRECTION**

The following figures show the image see from the front view. The arrow indicates the direction of scan.

#### Fig.1 Normal Scan



Fig.3 Reverse Scan



Fig.2 Reverse Scan



Fig.4 Reverse Scan



PCBA on the top side

PCBA on the top side

Fig. 1 Normal scan (pin 30,R/L=Low or NC, pin 31,U/D = High or NC)

Fig. 2 Reverse scan (pin 30,R/L=High, pin 31,U/D = High or NC )

- Fig. 3 Reverse scan (pin 30,R/L=Low or NC, pin 31,U/D = Low )
- Fig. 4 Reverse scan (pin 30,R/L=High, pin 31,U/D = Low )





### 7. OPTICAL CHARACTERISTICS

#### 7.1 TEST CONDITIONS

Item	Symbol	Value	Unit				
Ambient Temperature	Та	25±2	оС				
Ambient Humidity	На	50±10	%RH				
Supply Voltage	According to typical value and tolerance in						
Input Signal	"ELECTRICAL CHARACTERISTICS"						
PWM Duty Ratio	D	100	%				

#### 7.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown here and all items are measured at the center point of screen unless otherwise noted. The following items should be measured under the test conditions described above and stable conditions shown in Note (5).

Iter	n	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
	Pod	Rx		(0.602)	(0.652)	(0.702)		
	Reu	Ry		(0.286)	(0.336)	(0.386)	·	
	0	Gx		(0.271)	(0.321)	(0.371)		
Color Chromaticity	Green	Gy		(0.553)	(0.603)	(0.653)		(1) (5)
	Blue	Bx	θX=0°, θY =0°	(0.102)	(0.152)	(0.202)		(1), (3)
	Dide	Ву	Grayscale Maximum	(0.000)	(0.050)	(0.100)		
	\A/bita	Wx		(0.263)	(0.313)	(0.363)		
	vvriite	Wy		(0.279)	(0.329)	(0.379)		
Center Lumina	ince of White	LC			(360)	(450)		(4), (5)
Contras	t Ratio	CR			(600)	(800)		(2), (5)
Respons	o Timo	TR		-	(13)	(18)	-	(3)
Respons		TF	$0 \times -0$ , $0 \uparrow -0$	-	(12)	(17)	-	(3)
White Va	ariation	δW	θX=0°, θY =0°	(72)	(80)	-	%	(5), (6)
	Horizontal	θΧ+		80	88	-		
	Honzontai	θХ-		80	88	-	Dog	(1), (5)
	Vertical	θY+		80	88	-	Deg.	
	vertical	θY-		80	88	-		

Definition =

Grayscale Maximum : Grayscale 255 (10 bits: grayscale 1023 ; 8 bits : grayscale 255 ; 6 bits: grayscale 63) White : Luminance of Grayscale Maximum (All R,G,B)

Black : Luminance of grayscale 0 (All R,G,B)





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Note (1)Definition of Viewing Angle ( $\theta x, \theta y$ ):



#### Note (2)Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression at center point.

Contrast Ratio (CR) = White / Black

Note (3)Definition of Response Time ( $T_R$ ,  $T_F$ ):





Note (4) Definition of Luminance of White (Lc):

Measure the luminance of White at center point.

#### Note (5) Measurement Setup:

The LCD module should be stabilized at given temperature to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 40 minutes in a windless room. The measurement placement of module should be in accordance with module drawing.



Note (6) Definition of White Variation ( $\delta W$ ):

Measure the luminance of White at 5 points.

Luminance of White : L(X), where X is from 1 to 5.





#### 8. RELIABILITY TEST CRITERIA

Test Item	Test Condition	
High Temperature Storage Test	85°C, 240 hours	
Low Temperature Storage Test	-40°C, 240 hours	
Thermal Shock Storage Test	-30°C, 0.5 hour→→70°C, 0.5 hour; 100cycles, 1 hour/cycle)	(1) (2)
High Temperature Operation Test	85°C, 240 hours	(1),(2) (4),(5)
Low Temperature Operation Test	-30°C, 240 hours	( ),( )
High Temperature & High Humidity Operation Test	60℃, RH 90%, 240 hours	
	150pF, 330Ω, 1 sec/cycle	
ESD Test (Operation)	Test (Operation) Condition 1 : panel contact, ±8 KV	
	Condition 2 : panel non-contact ±15 KV	
Shock (Non-Operating)	50G, 11ms, half sine wave, 1 time for $\pm X$ , $\pm Y$ , $\pm Z$ direction	
Vibration (Non-Operating)	1.5G, 10 ~ 300 Hz sine wave, 10 min/cycle, 3 cycles each X, Y, Z direction	(2), (3)

Note (1)There should be no condensation on the surface of panel during test,

Note (2) Temperature of panel display surface area should be 85°C Max.

- Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.
- Note (4) In the standard conditions, there is no function failure issue occurred. All the cosmetic specification is judged before reliability test.
- Note (5) Before cosmetic and function test, the product must have enough recovery time, at least 24 hours at room temperature.



### 9. PACKAGING

### 9.1 PACKING SPECIFICATIONS

- (1) 60pcs LCD modules / 1 Box
- (2) Box dimensions: 500 (L) X 400 (W) X 330 (H) mm
- (3) Weight: approximately 11.65Kg (60 modules per box)

### 9.2 PACKING METHOD







Figure. 9-2 Packing

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Figure. 9-3 Un-packing method





### **10. DEFINITION OF LABELS**

### **10.1 INX MODULE LABEL**

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



Note (1) Safety Compliance(UL logo) will open after C1 version.

- (a) Model Name: G057VCE-TH1
- (b) \*\*\*\*: Factory ID

(c) Serial ID:	XXX	<u> </u>	YMDX	<u>N N N N</u>
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Serial ID includes the information as below:

(a) Manufactured Date: Year: 1~9, for 2021~2029

Month: 1~9, A~C, for Jan. ~ Dec.

Day: 1~9, A~Y, for  $1^{st}$  to  $31^{st},$  exclude I , O and U

(b) Revision Code: cover all the change

(c) Serial No.: Manufacturing sequence of product

V	ersion	0.	0
		•••	-



### **11. PRECAUTIONS**

### **11.1 ASSEMBLY AND HANDLING PRECAUTIONS**

- (1) The module should be assembled into the system firmly by using every mounting hole. Be careful not to twist or bend the module.
- (2) While assembling or installing modules, it can only be in the clean area. The dust and oil may cause electrical short or damage the polarizer.
- (3) Use fingerstalls or soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (4) Do not press or scratch the surface harder than a HB pencil lead on the panel because the polarizer is very soft and easily scratched.
- (5) If the surface of the polarizer is dirty, please clean it by some absorbent cotton or soft cloth. Do not use Ketone type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanently damage the polarizer due to chemical reaction.
- (6) Wipe off water droplets or oil immediately. Staining and discoloration may occur if they left on panel for a long time.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contacting with hands, legs or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static electricity, it may cause damage to the C-MOS Gate Array IC.
- (9) Do not disassemble the module.
- (10) Do not pull or fold the lamp wire.
- (11) Pins of I/F connector should not be touched directly with bare hands.

#### **11.2 STORAGE PRECAUTIONS**

(1) When storing for a long time, the following precautions are necessary.

- (a) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 30°C at humidity 50+-10%RH.
- (b) The polarizer surface should not come in contact with any other object.
- (c) It is recommended that they be stored in the container in which they were shipped.
- (d) Storage condition is guaranteed under packing conditions.
- (e)The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition
- (2) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (3) It is dangerous that moisture come into or contacted the LCD module, because the moisture may damage LCD module when it is operating.
- (4) It may reduce the display quality if the ambient temperature is lower than 10 °C. For example, the respons time will become slowly, and the starting voltage of lamp will be higher than the room temperature.

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### **11.3 OTHER PRECAUTIONS**

- (1) Normal operating condition
  - (a) Display pattern: dynamic pattern (Real display)
  - (Note) Long-term static display can cause image sticking.
- (2) Operating usages to protect against image sticking due to long-term static display
  - (a) Static information display recommended to use with moving image.
- (3) Abnormal condition just means conditions except normal condition.



## PRODUCT SPECIFICATION

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### **12. MECHANICAL CHARACTERISTICS**





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#### Appendix. SYSTEM COVER DESIGN NOTICE









Definition	a. To prevent from abnormal display & white spot after mechanical test, we suggest using Tape/Sponge as medium between chassis and Module rear cover could reduce the occurrence of white spot.
	b. When using the Tape/Sponge, we suggest it be lay over between set chassis and Module rear cover. It is not recommended to add Tape/Sponge in separate location. Since each Tape/Sponge may act as pressure concentration location.







4		Material used for system rear-cover		
		Module		
		Chassis		
		Z		
		System rear-cover		
Definitio	ion System rear-cover material with high rigidity is needed to resist deformation during scuffing test, hinge test, pogo test or backpack test. Abnormal display, white spot, pooling issue may occur if low rigidity material is used. Pooling issue may occur because screw's boss position for module's bracket are deformed open-close test. Solid structure design of system rear-cover may also influence the rigidity of system rear-cover. The deformation of system rear-cover should not caused interference.			

5	Assembly SOP examination for system front-cover with hook structure		
	Module hook		
	System rear-cover		
Definition	To prevent panel crack during system front-cover assembly process with hook structure, it is not recommended to press panel or any location that relate directly to the panel.		

































1	Sponge area design behind panel
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Definition	Sponge area design behind panel can not be across the panel metal rear and the reflector at the same time. It can be on the reflector area only.







4	Gap between panel & bezel
	2.Gap ≥ 0.1mm 1. Rib structure design holds the gap btw. bezel and panel surface.
Definition	<ul> <li>The gap between system bezel &amp; panel surface is needed to prevent pooling or glass broken. Zero gap or interference such as burr and warpage from mold frame may cause pooling issue near system font-cover opening edge. This phenomenon is obvious during swing test, hinge test, knock test, or during pooling inspection procedure.</li> <li>To remain the sufficient gap, design with system rib higher than maximum panel thickness is recommended.</li> <li>The sufficient gap design is greater or equal to 0.1mm.</li> </ul>













9	Material used for system rear-cover
	System rear-cover thickness:1 5mm
Definition	System rear-cover material with high rigidity is needed to resist deformation during
	scuffing test, hinge test, pogo test, or backpack test. Abnormal display, white spot, pooling issue may occur if low rigidity material is used. Solid structure design of system rear-cover may also influence the rigidity of system rear-cover. The deformation of system rear-cover should not caused interference.

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